# Product Change Notice

**Exar Corporation**  
www.exar.com | Support: customersupport@exar.com

**PCN Number:** 14-1249-03  
**Issue Date:** 13-JANUARY-2015

<table>
<thead>
<tr>
<th>PRODUCTS AFFECTED:</th>
<th>SP339EER1-L</th>
<th>SP339EER1-L/TR</th>
<th>SP339ECR1-L</th>
<th>SP339ECR1-L/TR</th>
</tr>
</thead>
</table>

## Change Category:

- [x] Material  
- [ ] Process  
- [ ] Package  
- [ ] Design  
- [ ] Datasheet  
- [ ] Packing/Shipping  
- [ ] Other

## Description of Change:

Qualified copper wire bonding assembly in addition to currently qualified gold wire bonding assembly in Unisem, Ipoh.

## Impact of Change:

There is no change to product form, fit or function.

## Target Implementation Date: 13-APRIL-2015

Please contact customer support (customersupport@exar.com) for sample date availability or qualification data.

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